

# TDA7331

## SINGLE CHIP RDS DEMODULATOR + FILTER

- VERY HIGH RDS DEMODULATION QUALITY WITH IMPROVED DIGITAL SIGNAL PROC-ESSING
- HIGH PERFORMANCE, 57KHz BANDPASS FILTER (8th ORDER)
- PURELY DIGITAL RDS DEMODULATION WITHOUT EXTERNAL COMPONENTS
- ARI INDICATION AND RDS SIGNAL QUAL-ITY OUTPUTS
- 4.332MHz CRYSTAL OSCILLATOR (8.664 and 17.328MHz SELECTABLE OP-TIONS)
- LOW NOISE CMOS TECHNOLOGY
- LOW RADIATION

#### DESCRIPTION

The TDA7331, an improved version of TDA7330B, recovers the additional inaudible RDS information which is transmitted by FM radio broadcasting stations and operates in accordance with the EBU (European Broadcasting Union) specifications.

The device is made up of two sections: a cas-

#### **BLOCK DIAGRAM and TEST CIRCUIT**



caded antialiasing + switched capacitors bandpass filter for precise RDS band selection and a demodulating section that performs the extraction od RDS data stream (RDDA) and clock (RDCL), to be furher processed by a suitable RDS decoder.

Outputs for RDS signal quality and ARI indication are also present.



Symbol		Parameter	Value	Unit			
Vs	Supply Volt	age	7	V			
T <sub>op</sub>	Operating T	emperature Range	-40 to 85	°C			
T <sub>stg</sub>	Storage Ter	nperature	-55 to 150	°C			
PIN FUN	CTION						
N <sup>o</sup> pin	Name	Functional descr	iption				
1	MPX	RDS input signal	•				
2	VREF	Reference voltage					
3	OSEL	Oscillator selector pin: - open, or closed to Vs = q - closed to GND = external					
4	FILOUT	Filter output					
5	GND	Ground					
6	nc	Not connected					
7	nc	Not connected					
8	nc	Not connected					
9	OSCOUT	Oscillator output					
10	OSCIN	Oscillator input					
11	T57	Testing output pin: 57kHz clock output					
12	RDCL	RDS clock output 1187.5Hz					
13	RDDA	RDS data output					
14	QUAL	Output for signal quality indication (High = good)					
15	ARI	Output for ARI indication: - high when RDS+ARI are present - high when only ARI is present - low when only RDS is present - undefined when nos signal is present					
16	Vs	Supply voltage	<u>v</u>				
17	nc	Not connected					
18	FSEL	Frequency selector pin: - 100K to $V_S = 17.328MHz$ - open = 4.332MHz - closed to $V_S = 8.664MHz$					
19	ТМ	Test mode pin: - open = normal operation - closed to $V_S$ = testmode					
20	EXTRES	Reset pin: - open = run mode					

#### **PIN CONNECTION**



- closed to  $V_s$  = reset condition

#### THERMAL DATA

Symbol	Description	DIP20	SO20	Unit
R <sub>th j-amb</sub>	Thermal Resistance Junction-Ambient Max	100	200	°C/W

**ELECTRICAL CHARACTERISTICS** ( $T_{amb} = 25^{\circ}C$ ,  $V_{S} = 5V$ , unless otherwise specified).

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
Vs	Supply voltage		4.5	5	5.5	V
Is	Supply current			7.5	11.0	mA
FILTER						
f <sub>C</sub>	Center frequency		56.5	57	57.5	kHz
BW	3dB Bandwidth		2.5	3	3.5	kHz
G	Gain	f = 57kHz	18	20	22	dB
А	Attenuation	$\Delta f \pm 4 kHz$	18	22		dB
		f = 38kHz	50	60		dB
		f = 67kHz	35	45		dB
RI	Input impedance of MPX		80	120	150	KΩ
RL	Load impedance on FILOUT		1			MΩ
S/N	Signal to noise ratio	$V_{IN} = 3mV_{RMS}$	30	40		dB
V <sub>IN</sub>	MPX input signal	f = 19kHz; T3 ≤ 40dB(1) f = 57kHz (RDS+ ARI)			1000 50	mV <sub>RMS</sub> mV <sub>RMS</sub>
V <sub>REF</sub>	Reference			V <sub>S</sub> /2		V
DEMODUI Input pins Input pin (	(EXTRES, FSEL, TM)		all with ir wit	nternal pu h internal		
IPD	Input Current	$V_{IN} = 5V$ (pull-down input)	15		30	μA
I <sub>PU</sub>	Input Current	$V_{IN} = 0V$ (pull-up input)	-25		-10	μΑ
VIH	Input voltage high		$0.7 \cdot V_S$	$0.8 \cdot V_S$		, V
VIL	Input voltage low			0.2 · Vs	0.3 · Vs	V
Output pin	is (RDCL, RDDA, ARI, QUAL, T5	7)	I			•
V <sub>OH</sub>	Ouput voltage high	I <sub>L</sub> = 0.5mA	4	4.6		V
V <sub>OL</sub>	Output voltage low	$I_L = 0.5 \text{mA}$		0.4	1	V
OSCILLA <sup>-</sup>	TOR					
VCLL	Input level OSCIN pin	OSEL = open circuit			1	V
VCLH	Input level OSCIN pin	OSEL = open circuit	4			V
	Amplitude OSCOUT	OSEL = open circuit		4.5		V
$V_{PP}$	Amplitude OSCIN (for external drive)	OSEL = GND, f = 4.332MHz		100		mVpp
		OSEL = GND, f = 8.664MHz		120		mVpp
		1 = 0.00410112				

(1) The 3rd harmonic (57kHz) must be less than -40dB with respect to the input signal plus gain.

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#### Figure 1. RDS timing diagram



#### **OUTPUT TIMING**

The RDS (1187.5Hz) output clock on RDCL line is synchronized to the incoming data.

According to the internal PLL lock condition data change can result on the falling or on the rising clock edge. (see Fig. 1)

Whichever clock edge is used by the decoder (rising or falling edge) the data will remain valid for 416.7  $\mu$ sec after the clock transition.

#### **OSCILLATOR CONTROLS (FSEL, OSEL)**

Three different crystal frequencies can be used. The adaption of the internal clock divider to the external crystal is achieved via the input pin FSEL. See the followings table for reference:

Crystal	FSEL (pin configuration)
4.332MHz	connected to GND or open
8.664MHz	connected to Vs
17.328MHz	external resistor of 100K to Vs

A special mode is introduced to reduce EMI. With pin OSEL connected to GND the internal oscillator is switched off and an external sinusoidal frequency could be applied on OSCIN. The peak to peak voltage of this signal can be reduced down to 60mV.

In this mode the frequency selection via FSEL is still active.

Suggested values of C1 and C2 are shown in the following table:

Crystal	C1	C2
4.332MHz	27pF	47pF
8.664MHz	27pF	-
17.328MHz	27pF	-

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DIM.		mm		inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.254			0.010		
В	1.39		1.65	0.055		0.065
b		0.45			0.018	
b1		0.25			0.010	
D			25.4			1.000
E		8.5			0.335	
е		2.54			0.100	
e3		22.86			0.900	
F			7.1			0.280
I			3.93			0.155
L		3.3			0.130	
Z			1.34			0.053

#### DIP20 PACKAGE MECHANICAL DATA



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### TDA7331

#### SO20 PACKAGE MECHANICAL DATA

DIM.		mm			inch	
Diwi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А			2.65			0.104
a1	0.1		0.3	0.004		0.012
a2			2.45			0.096
b	0.35		0.49	0.014		0.019
b1	0.23		0.32	0.009		0.013
С		0.5			0.020	
c1			45 (	(typ.)		
D	12.6		13.0	0.496		0.512
E	10		10.65	0.394		0.419
е		1.27			0.050	
e3		11.43			0.450	
F	7.4		7.6	0.291		0.299
L	0.5		1.27	0.020		0.050
М			0.75			0.030
S	8 (max.)					



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